SILICON TRANSISTORS 2SC2148, 2SC2149

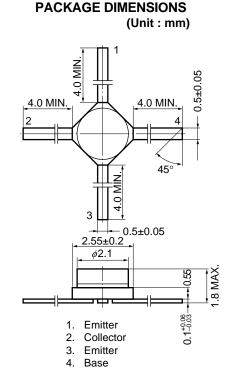
MICROWAVE LOW NOISE AMPLIFIER NPN SILICON EPITAXIAL TRANSISTOR

DESCRIPTION

The 2SC2148, 2SC2149 are economical microwave transistors encapsulated into new hermetic stripline packages, "micro X". These are designed for small signal amplifier, low noise amplifier, and oscillator applications in the L to C band, and CML circuit use.

FEATURES

2SC2148 NF: 2.1 dB TYP. @f = 500 MHz 2SC2149 NF: 2.6 dB TYP. @f = 2.0 GHz



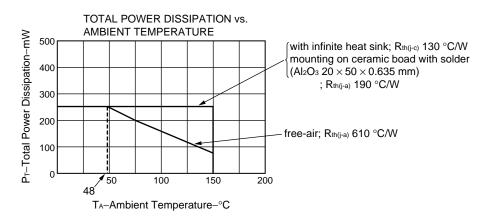
Derating curves of the 2SC2148, 2SC2149.

The maximum junction temperature of these transistors is allowed up to 200 °C, but the ambient or storage temperature is limitted to 150 °C. The operating junction temperature is estimated with power consumption (P_T) and thermal resistance mentioned on these derating curves.

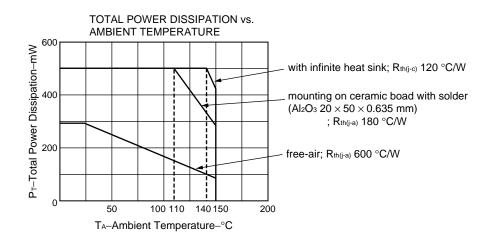
The information in this document is subject to change without notice.

NEC

2SC2148



2SC2149



2SC2148

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

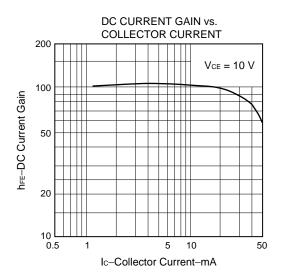
Collector to Base Voltage	Vсво	30	V
Collector to Emitter Voltage	Vceo	14	V
Emitter to Base Voltage	Vево	3.0	V
Collector Current	Ic	50	mA
Total Power Dissipation	PT(T _A = 48 °C)	250	mW
Total Power Dissipation	PT(Tc = 150 °C)	250	mW
Junction Temperature	Tj	200	°C
Storage Temperature	Tstg	-65 to +150	°C

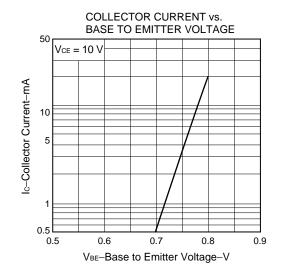
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

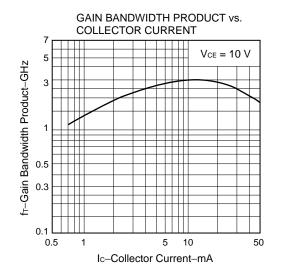
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Collector Cutoff Current	Ісво			0.1	μA	Vсв = 15 V, IE = 0
Emitter Cutoff Current	Іево			0.1	μA	VEB = 2.0 V, Ic = 0
DC Current Gain	hfe	30	80	200		Vce = 10 V, Ic = 10 mA
Gain Bandwidth Product	fr		3.0		GHz	Vce = 10 V, Ic = 10 mA
Output Capacitance *	Cob		0.55		pF	Vсв = 10 V, IE = 0, f = 1.0 MHz
Insertion Gain	S _{21e} ²	7.5	9.3		dB	Vce = 10 V, Ic = 10 mA, f = 1.0 GHz
Noise Figure	NF		2.1	3.5	dB	Vce = 10 V, Ic = 3.0 mA, f = 500 MHz
Maximum Available Gain	MAG		13.3		dB	Vce = 10 V, Ic = 10 mA, f = 1.0 GHz

* The emitter terminal should be connected to the guard terminal of the three-terminal capacitance bridge.

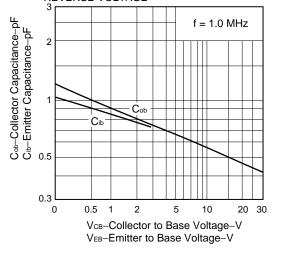
TYPICAL CHARACTERISTICS (TA = 25 °C)

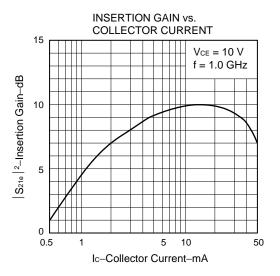


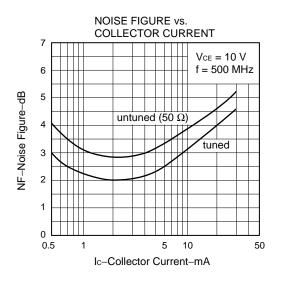




COLLECTOR AND EMITTER CAPACITANCE vs. REVERSE VOLTAGE







2SC2149

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

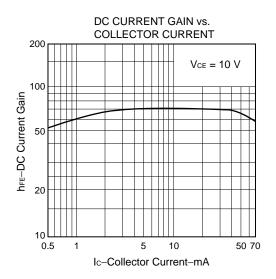
Collector to Base Voltage	Vсво	25	V
Collector to Emitter Voltage	Vceo	12	V
Emitter to Base Voltage	Vево	3.0	V
Collector Current	Ic	70	mA
Total Power Dissipation	PT(T _A = 25 °C)	290	mW
Total Power Dissipation	PT(Tc = 140 °C)	500	mW
Junction Temperature	Tj	200	°C
Storage Temperature	Tstg	-65 to +150	°C

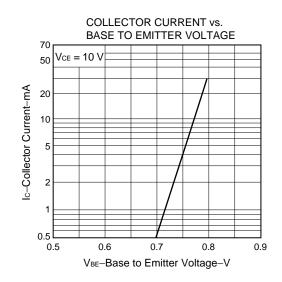
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

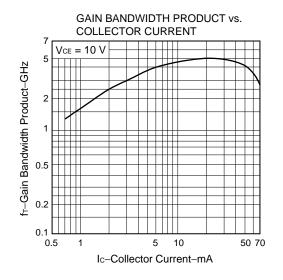
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Collector Cutoff Current	Ісво			0.1	μA	Vсв = 15 V, IE = 0	
Emitter Cutoff Current	Іево			0.1	μA	VEB = 2.0 V, Ic = 0	
DC Current Gain	hfe	30	70	200		Vce = 10 V, Ic = 20 mA	
Gain Bandwidth Product	fт		5.0		GHz	Vce = 10 V, Ic = 20 mA	
Output Capacitance *	Cob		0.6		pF	Vcb = 10 V, IE = 0, f = 1.0 MHz	
Insertion Gain	S 21e 2		12.7		dB	Vce = 10 V, Ic = 20 mA	f = 1.0 GHz
	3 21e ²	5.0	6.7		dB		f = 2.0 GHz
Noise Figure			1.7		dB	Vce = 10 V, Ic = 5.0 mA	f = 1.0 GHz
	NF		2.6	4.0	dB		f = 2.0 GHz
Maximum Available Gain	MAG		17		dB	Vce = 10 V, Ic = 20 mA	f = 1.0 GHz
	MAG		11		dB		f = 2.0 GHz

* The emitter terminal should be connected to the guard terminal of the three-terminal capacitance bridge.

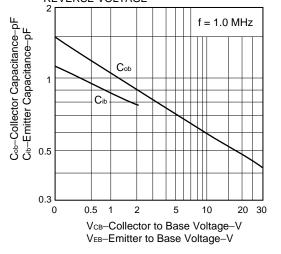
TYPICAL CHARACTERISTICS (T_A = 25 °C)

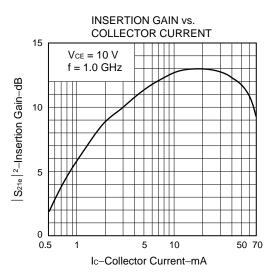


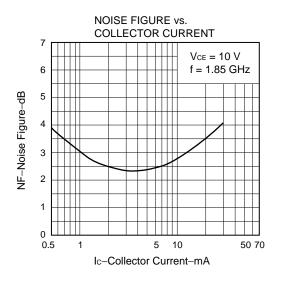




COLLECTOR AND EMITTER CAPACITANCE vs. REVERSE VOLTAGE







[MEMO]

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- Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
- Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

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Anti-radioactive design is not implemented in this product.